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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details	
Product Status	Obsolete
Number of LABs/CLBs	3005
Number of Logic Elements/Cells	60100
Total RAM Bits	2528640
Number of I/O	514
Number of Gates	-
Voltage - Supply	1.15V ~ 1.25V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	1152-BBGA
Supplier Device Package	1152-FBGA (35x35)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep1agx60ef1152i6n

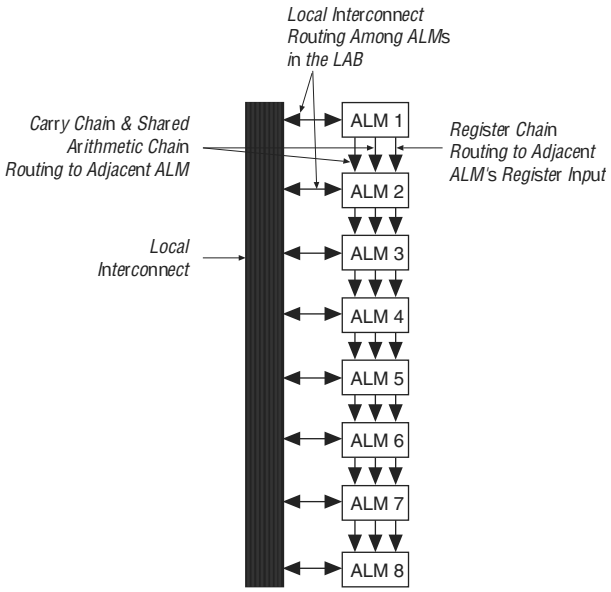
Logic Array Blocks

Each logic array block (LAB) consists of eight adaptive logic modules (ALMs), carry chains, shared arithmetic chains, LAB control signals, local interconnects, and register chain connection lines. The local interconnect transfers signals between ALMs in the same LAB. Register chain connections transfer the output of an ALM register to the adjacent ALM register in a LAB. The Quartus II Compiler places associated logic in a LAB or adjacent LABs, allowing the use of local, shared arithmetic chain, and register chain connections for performance and area efficiency. Table 2–9 lists Arria GX device resources. Figure 2–25 shows the Arria GX LAB structure.

Table 2–9. Arria GX Device Resources

Device	M512 RAM Columns/Blocks	M4K RAM Columns/Blocks	M-RAM Blocks	DSP Block Columns/Blocks
EP1AGX20	166	118	1	10
EP1AGX35	197	140	1	14
EP1AGX50	313	242	2	26
EP1AGX60	326	252	2	32
EP1AGX90	478	400	4	44

Figure 2–40. Shared Arithmetic Chain, Carry Chain and Register Chain Interconnects



C4 interconnects span four LABs, M512, or M4K blocks up or down from a source LAB. Every LAB has its own set of C4 interconnects to drive either up or down. Figure 2–41 shows the C4 interconnect connections from a LAB in a column. C4 interconnects can drive and be driven by all types of architecture blocks, including DSP blocks, TriMatrix memory blocks, and column and row IOEs. For LAB interconnection, a primary LAB or its LAB neighbor can drive a given C4 interconnect. C4 interconnects can drive each other to extend their range as well as drive row interconnects for column-to-column connections.

For the specific sustaining current driven through this resistor and overdrive current used to identify the next-driven input level, refer to the *DC & Switching Characteristics* chapter.

Programmable Pull-Up Resistor

Each Arria GX device I/O pin provides an optional programmable pull-up resistor during user mode. If you enable this feature for an I/O pin, the pull-up resistor (typically 25 kΩ) holds the output to the V_{CCIO} level of the output pin's bank.

Advanced I/O Standard Support

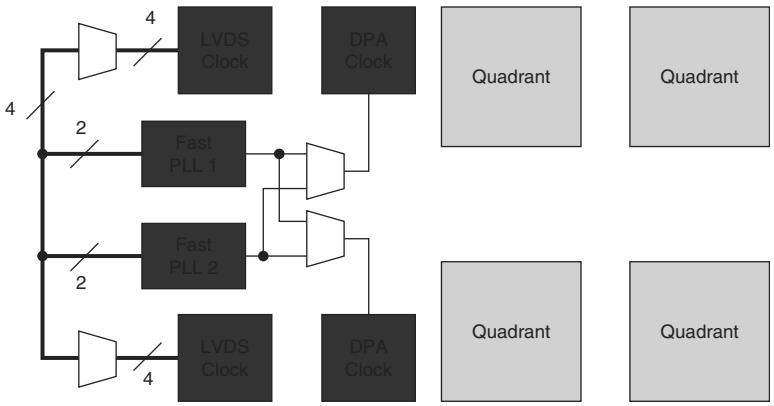
Arria GX device IOEs support the following I/O standards:

- 3.3-V LVTTL/LVCMOS
- 2.5-V LVTTL/LVCMOS
- 1.8-V LVTTL/LVCMOS
- 1.5-V LVCMOS
- 3.3-V PCI
- 3.3-V PCI-X mode 1
- LVDS
- LVPECL (on input and output clocks only)
- Differential 1.5-V HSTL class I and II
- Differential 1.8-V HSTL class I and II
- Differential SSTL-18 class I and II
- Differential SSTL-2 class I and II
- 1.2-V HSTL class I and II
- 1.5-V HSTL class I and II
- 1.8-V HSTL class I and II
- SSTL-2 class I and II
- SSTL-18 class I and II

Fast PLL and Channel Layout

The receiver and transmitter channels are interleaved as such that each I/O bank on the left side of the device has one receiver channel and one transmitter channel per LAB row. Figure 2–81 shows the fast PLL and channel layout in the EP1AGX20C, EP1AGX35C/D, EP1AGX50C/D and EP1AGX60C/D devices. Figure 2–82 shows the fast PLL and channel layout in EP1AGX60E and EP1AGX90E devices.

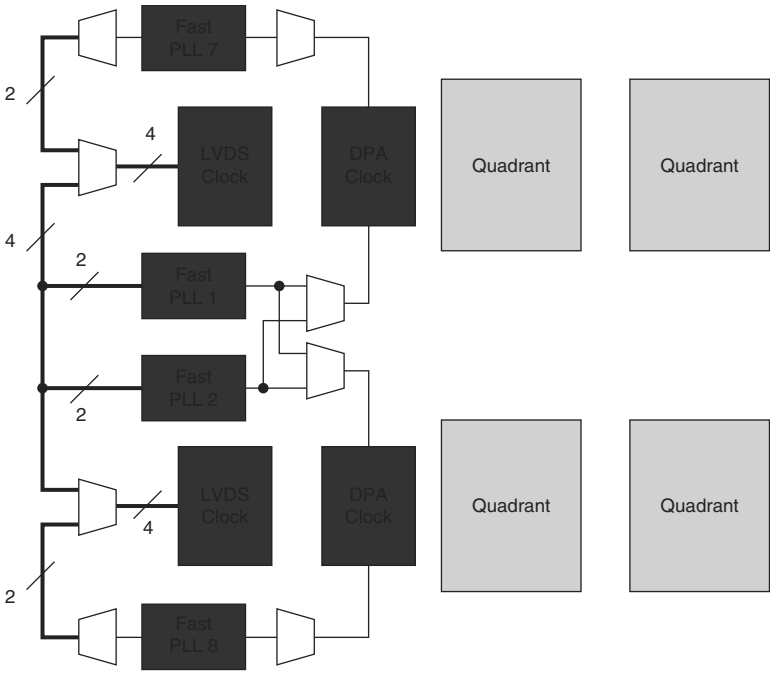
Figure 2–81. Fast PLL and Channel Layout in EP1AGX20C, EP1AGX35C/D, EP1AGX50C/D, EP1AGX60C/D Devices *(Note 1)*



Note to Figure 2–81:

(1) For the number of channels each device supports, refer to Table 2–30.

Figure 2–82. Fast PLL and Channel Layout in EP1AGX60E and EP1AGX90E Devices *(Note 1)*



Note to Figure 2–82:

(1) For the number of channels each device supports, refer to Table 2–30 through Table 2–34.

Configuring Arria GX FPGAs with JRunner

The JRunner software driver configures Altera FPGAs, including Arria GX FPGAs, through the ByteBlaster™ II or ByteBlasterMV cables in JTAG mode. The programming input file supported is in Raw Binary File (**.rbf**) format. JRunner also requires a Chain Description File (**.cdf**) generated by the Quartus II software. JRunner is targeted for embedded JTAG configuration. The source code is developed for the Windows NT operating system (OS), but can be customized to run on other platforms.

For more information about the JRunner software driver, refer to the *AN414: JRunner Software Driver: An Embedded Solution for PLD JTAG Configuration* and the source files on the Altera website.

Programming Serial Configuration Devices with SRunner

You can program a serial configuration device in-system by an external microprocessor using SRunner™. SRunner is a software driver developed for embedded serial configuration device programming that can be easily customized to fit into different embedded systems. SRunner software driver reads a raw programming data file (**.rpd**) and writes to serial configuration devices. The serial configuration device programming time using SRunner software driver is comparable to the programming time when using the Quartus II software.

For more information about SRunner, refer to the *AN418: SRunner: An Embedded Solution for Serial Configuration Device Programming* and the source code on the Altera website.

For more information about programming serial configuration devices, refer to the *Serial Configuration Devices (EPCS1, EPCS4, EPCS64, and EPCS128) Data Sheet* in the *Configuration Handbook*.

Configuring Arria GX FPGAs with the MicroBlaster Driver

The MicroBlaster™ software driver supports a raw binary file (RBF) programming input file and is ideal for embedded FPP or PS configuration. The source code is developed for the Windows NT operating system, although it can be customized to run on other operating systems.

For more information about the MicroBlaster software driver, refer to the *Configuring the MicroBlaster Fast Passive Parallel Software Driver White Paper* or the *AN423: Configuring the MicroBlaster Passive Serial Software Driver*.

PLL Reconfiguration

The phase-locked loops (PLLs) in the Arria GX device family support reconfiguration of their multiply, divide, VCO-phase selection, and bandwidth selection settings without reconfiguring the entire device. You can use either serial data from the logic array or regular I/O pins to program the PLL's counter settings in a serial chain. This option provides considerable flexibility for frequency synthesis, allowing real-time variation of the PLL frequency and delay. The rest of the device is functional while reconfiguring the PLL.

Document Revision History

Table 3–5 lists the revision history for this chapter.

Table 3–5. Document Revision History

Date and Document Version	Changes Made	Summary of Changes
December 2009, v2.0	■ Document template update. ■ Minor text edits.	—
May 2009 v1.4	■ Removed "Temperature Sensing Diode" section. ■ Updated Table 3–1 and Table 3–4.	—
May 2008 v1.3	Updated note in "Introduction" section.	
	Minor text edits.	—
August 2007 v1.2	Added the "Referenced Documents" section.	—
June 2007 v1.1	Deleted Signal Tap II information from Table 3–1.	—
May 2007 v1.0	Initial Release	—

Table 4–36. 1.8-V HSTL Class I Specifications

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
V_{CCIO}	Output supply voltage	—	1.71	1.80	1.89	V
V_{REF}	Input reference voltage	—	0.85	0.90	0.95	V
V_{TT}	Termination voltage	—	0.85	0.90	0.95	V
V_{IH} (DC)	DC high-level input voltage	—	V_{REF} + 0.1	—	—	V
V_{IL} (DC)	DC low-level input voltage	—	–0.3	—	V_{REF} – 0.1	V
V_{IH} (AC)	AC high-level input voltage	—	V_{REF} + 0.2	—	—	V
V_{IL} (AC)	AC low-level input voltage	—	—	—	V_{REF} – 0.2	V
V_{OH}	High-level output voltage	I_{OH} = 8 mA *(1)*	V_{CCIO} – 0.4	—	—	V
V_{OL}	Low-level output voltage	I_{OH} = –8 mA *(1)*	—	—	0.4	V

Note to Table 4–36:

(1) This specification is supported across all the programmable drive settings available for this I/O standard, as shown in the *Arria GX Architecture* chapter.

Table 4–37. 1.8-V HSTL Class II Specifications

Symbol	Parameter	Conditions	Minimum	Typical	Maximum	Units
V_{CCIO}	Output supply voltage	—	1.71	1.80	1.89	V
V_{REF}	Input reference voltage	—	0.85	0.90	0.95	V
V_{TT}	Termination voltage	—	0.85	0.90	0.95	V
V_{IH} (DC)	DC high-level input voltage	—	V_{REF} + 0.1	—	—	V
V_{IL} (DC)	DC low-level input voltage	—	–0.3	—	V_{REF} – 0.1	V
V_{IH} (AC)	AC high-level input voltage	—	V_{REF} + 0.2	—	—	V
V_{IL} (AC)	AC low-level input voltage	—	—	—	V_{REF} – 0.2	V
V_{OH}	High-level output voltage	I_{OH} = 16 mA *(1)*	V_{CCIO} – 0.4	—	—	V
V_{OL}	Low-level output voltage	I_{OH} = –16 mA *(1)*	—	—	0.4	V

Note to Table 4–37:

(1) This specification is supported across all the programmable drive settings available for this I/O standard, as shown in the *Arria GX Architecture* chapter in volume 1 of the *Arria GX Device Handbook*.

Table 4–38. 1.8-V HSTL Class I & II Differential Specifications

Symbol	Parameter	Minimum	Typical	Maximum	Units
V_{CCIO}	I/O supply voltage	1.71	1.80	1.89	V
V_{DIF} (DC)	DC input differential voltage	0.2	—	—	V
V_{CM} (DC)	DC common mode input voltage	0.78	—	1.12	V
V_{DIF} (AC)	AC differential input voltage	0.4	—	—	V
V_{OX} (AC)	AC differential cross point voltage	0.68	—	0.9	V

For more information about PowerPlay tools, refer to the *PowerPlay Early Power Estimator and PowerPlay Power Analyzer* page and the *PowerPlay Power Analysis* chapter in volume 3 of the *Quartus II Handbook*.

For typical I_{CC} standby specifications, refer to Table 4–14 on page 4–14 .

I/O Timing Model

The DirectDrive technology and MultiTrack interconnect ensures predictable performance, accurate simulation, and accurate timing analysis across all Arria GX device densities and speed grades. This section describes and specifies the performance of I/Os.

All specifications are representative of worst-case supply voltage and junction temperature conditions.

The timing numbers listed in the tables of this section are extracted from the Quartus II software version 7.1.

Preliminary, Correlated, and Final Timing

Timing models can have either preliminary, correlated, or final status. The Quartus II software issues an informational message during design compilation if the timing models are preliminary. Table 4–43 lists the status of the Arria GX device timing models.

- **Preliminary** status means the timing model is subject to change. Initially, timing numbers are created using simulation results, process data, and other known parameters. These tests are used to make the preliminary numbers as close to the actual timing parameters as possible.
- **Correlated** numbers are based on actual device operation and testing. These numbers reflect the actual performance of the device under worst-case voltage and junction temperature conditions.
- **Final timing** numbers are based on complete correlation to actual devices and addressing any minor deviations from the correlated timing model. When the timing models are final, all or most of the Arria GX family devices have been completely characterized and no further changes to the timing model are expected.

Table 4–43. Arria GX Device Timing Model Status

Device	Preliminary	Correlated	Final
EP1AGX20	—	—	✓
EP1AGX35	—	—	✓
EP1AGX50	—	—	✓
EP1AGX60	—	—	✓
EP1AGX90	—	—	✓

Figure 4–9. Measurement Setup for t_{zx}

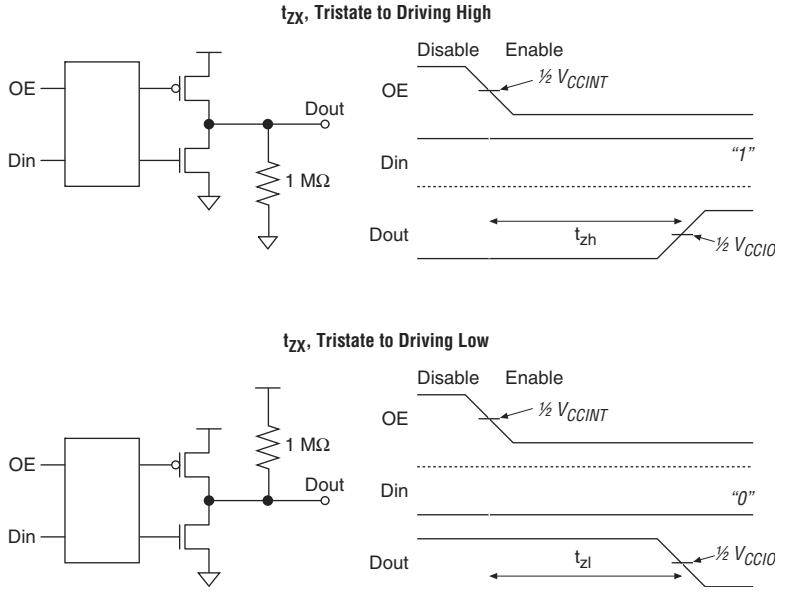


Table 4–45 specifies the input timing measurement setup.

Table 4–45. Timing Measurement Methodology for Input Pins *(Note 1)*, *(2)*, *(3)*, *(4)* (Part 1 of 2)

I/O Standard	Measurement Conditions			Measurement Point
	V_{CCIO} (V)	V_{REF} (V)	Edge Rate (ns)	VMEAS (V)
LVTTL *(5)*	3.135	—	3.135	1.5675
LVCMOS *(5)*	3.135	—	3.135	1.5675
2.5 V *(5)*	2.375	—	2.375	1.1875
1.8 V *(5)*	1.710	—	1.710	0.855
1.5 V *(5)*	1.425	—	1.425	0.7125
PCI *(6)*	2.970	—	2.970	1.485
PCI-X *(6)*	2.970	—	2.970	1.485
SSTL-2 Class I	2.325	1.163	2.325	1.1625
SSTL-2 Class II	2.325	1.163	2.325	1.1625
SSTL-18 Class I	1.660	0.830	1.660	0.83
SSTL-18 Class II	1.660	0.830	1.660	0.83
1.8-V HSTL Class I	1.660	0.830	1.660	0.83
1.8-V HSTL Class II	1.660	0.830	1.660	0.83
1.5-V HSTL Class I	1.375	0.688	1.375	0.6875
1.5-V HSTL Class II	1.375	0.688	1.375	0.6875
1.2-V HSTL with OCT	1.140	0.570	1.140	0.570
Differential SSTL-2 Class I	2.325	1.163	2.325	1.1625
Differential SSTL-2 Class II	2.325	1.163	2.325	1.1625
Differential SSTL-18 Class I	1.660	0.830	1.660	0.83

Table 4–48. EP1AGX20 Row Pin Delay Adders for Regional Clock

Parameter	Fast Corner		–6 Speed Grade	Units
	Industrial	Commercial		
RCLK input adder	0.117	0.117	0.273	ns
RCLK PLL input adder	0.011	0.011	0.019	ns
RCLK output adder	–0.117	–0.117	–0.273	ns
RCLK PLL output adder	–0.011	–0.011	–0.019	ns

Table 4–49 describes I/O timing specifications.

Table 4–49. EP1AGX20 Column Pins Input Timing Parameters (Part 1 of 3)

I/O Standard	Clock	Parameter	Fast Corner		–6 Speed Grade	Units
			Industrial	Commercial		
3.3-V LVTTL	GCLK	t_{SU}	1.251	1.251	2.915	ns
		t_H	–1.146	–1.146	–2.638	ns
	GCLK PLL	t_{SU}	2.693	2.693	6.021	ns
		t_H	–2.588	–2.588	–5.744	ns
3.3-V LVCMOS	GCLK	t_{SU}	1.251	1.251	2.915	ns
		t_H	–1.146	–1.146	–2.638	ns
	GCLK PLL	t_{SU}	2.693	2.693	6.021	ns
		t_H	–2.588	–2.588	–5.744	ns
2.5 V	GCLK	t_{SU}	1.261	1.261	2.897	ns
		t_H	–1.156	–1.156	–2.620	ns
	GCLK PLL	t_{SU}	2.703	2.703	6.003	ns
		t_H	–2.598	–2.598	–5.726	ns
1.8 V	GCLK	t_{SU}	1.327	1.327	3.107	ns
		t_H	–1.222	–1.222	–2.830	ns
	GCLK PLL	t_{SU}	2.769	2.769	6.213	ns
		t_H	–2.664	–2.664	–5.936	ns
1.5 V	GCLK	t_{SU}	1.330	1.330	3.200	ns
		t_H	–1.225	–1.225	–2.923	ns
	GCLK PLL	t_{SU}	2.772	2.772	6.306	ns
		t_H	–2.667	–2.667	–6.029	ns
SSTL-2 CLASS I	GCLK	t_{SU}	1.075	1.075	2.372	ns
		t_H	–0.970	–0.970	–2.095	ns
	GCLK PLL	t_{SU}	2.517	2.517	5.480	ns
		t_H	–2.412	–2.412	–5.203	ns

Table 4–50. EP1AGX20 Row Pins output Timing Parameters (Part 2 of 2)

I/O Standard	Drive Strength	Clock	Parameter	Fast Model		–6 Speed Grade	Units
				Industrial	Commercial		
SSTL-2 CLASS I	8 mA	GCLK	t_{CO}	2.626	2.626	5.614	ns
		GCLK PLL	t_{CO}	1.207	1.207	2.542	ns
SSTL-2 CLASS I	12 mA	GCLK	t_{CO}	2.602	2.602	5.538	ns
		GCLK PLL	t_{CO}	1.183	1.183	2.466	ns
SSTL-2 CLASS II	16 mA	GCLK	t_{CO}	2.568	2.568	5.407	ns
		GCLK PLL	t_{CO}	1.149	1.149	2.335	ns
SSTL-18 CLASS I	4 mA	GCLK	t_{CO}	2.614	2.614	5.556	ns
		GCLK PLL	t_{CO}	1.195	1.195	2.484	ns
SSTL-18 CLASS I	6 mA	GCLK	t_{CO}	2.618	2.618	5.485	ns
		GCLK PLL	t_{CO}	1.199	1.199	2.413	ns
SSTL-18 CLASS I	8 mA	GCLK	t_{CO}	2.594	2.594	5.468	ns
		GCLK PLL	t_{CO}	1.175	1.175	2.396	ns
SSTL-18 CLASS I	10 mA	GCLK	t_{CO}	2.597	2.597	5.447	ns
		GCLK PLL	t_{CO}	1.178	1.178	2.375	ns
1.8-V HSTL CLASS I	4 mA	GCLK	t_{CO}	2.595	2.595	5.466	ns
		GCLK PLL	t_{CO}	1.176	1.176	2.394	ns
1.8-V HSTL CLASS I	6 mA	GCLK	t_{CO}	2.598	2.598	5.430	ns
		GCLK PLL	t_{CO}	1.179	1.179	2.358	ns
1.8-V HSTL CLASS I	8 mA	GCLK	t_{CO}	2.580	2.580	5.426	ns
		GCLK PLL	t_{CO}	1.161	1.161	2.354	ns
1.8-V HSTL CLASS I	10 mA	GCLK	t_{CO}	2.584	2.584	5.415	ns
		GCLK PLL	t_{CO}	1.165	1.165	2.343	ns
1.8-V HSTL CLASS I	12 mA	GCLK	t_{CO}	2.575	2.575	5.414	ns
		GCLK PLL	t_{CO}	1.156	1.156	2.342	ns
1.5-V HSTL CLASS I	4 mA	GCLK	t_{CO}	2.594	2.594	5.443	ns
		GCLK PLL	t_{CO}	1.175	1.175	2.371	ns
1.5-V HSTL CLASS I	6 mA	GCLK	t_{CO}	2.597	2.597	5.429	ns
		GCLK PLL	t_{CO}	1.178	1.178	2.357	ns
1.5-V HSTL CLASS I	8 mA	GCLK	t_{CO}	2.582	2.582	5.421	ns
		GCLK PLL	t_{CO}	1.163	1.163	2.349	ns
LVDS	—	GCLK	t_{CO}	2.654	2.654	5.613	ns
		GCLK PLL	t_{CO}	1.226	1.226	2.530	ns

Table 4–51. EP1AGX20 Column Pins Output Timing Parameters (Part 2 of 4)

I/O Standard	Drive Strength	Clock	Parameter	Fast Corner		–6 Speed Grade	Units
				Industrial	Commercial		
1.8 V	6 mA	GCLK	t_{CO}	2.695	2.695	6.155	ns
		GCLK PLL	t_{CO}	1.253	1.253	3.049	ns
1.8 V	8 mA	GCLK	t_{CO}	2.697	2.697	6.064	ns
		GCLK PLL	t_{CO}	1.255	1.255	2.958	ns
1.8 V	10 mA	GCLK	t_{CO}	2.651	2.651	5.987	ns
		GCLK PLL	t_{CO}	1.209	1.209	2.881	ns
1.8 V	12 mA	GCLK	t_{CO}	2.652	2.652	5.930	ns
		GCLK PLL	t_{CO}	1.210	1.210	2.824	ns
1.5 V	2 mA	GCLK	t_{CO}	2.746	2.746	6.723	ns
		GCLK PLL	t_{CO}	1.304	1.304	3.617	ns
1.5 V	4 mA	GCLK	t_{CO}	2.682	2.682	6.154	ns
		GCLK PLL	t_{CO}	1.240	1.240	3.048	ns
1.5 V	6 mA	GCLK	t_{CO}	2.685	2.685	6.036	ns
		GCLK PLL	t_{CO}	1.243	1.243	2.930	ns
1.5 V	8 mA	GCLK	t_{CO}	2.644	2.644	5.983	ns
		GCLK PLL	t_{CO}	1.202	1.202	2.877	ns
SSTL-2 CLASS I	8 mA	GCLK	t_{CO}	2.629	2.629	5.762	ns
		GCLK PLL	t_{CO}	1.184	1.184	2.650	ns
SSTL-2 CLASS I	12 mA	GCLK	t_{CO}	2.612	2.612	5.712	ns
		GCLK PLL	t_{CO}	1.167	1.167	2.600	ns
SSTL-2 CLASS II	16 mA	GCLK	t_{CO}	2.590	2.590	5.639	ns
		GCLK PLL	t_{CO}	1.145	1.145	2.527	ns
SSTL-2 CLASS II	20 mA	GCLK	t_{CO}	2.591	2.591	5.626	ns
		GCLK PLL	t_{CO}	1.146	1.146	2.514	ns
SSTL-2 CLASS II	24 mA	GCLK	t_{CO}	2.587	2.587	5.624	ns
		GCLK PLL	t_{CO}	1.142	1.142	2.512	ns
SSTL-18 CLASS I	4 mA	GCLK	t_{CO}	2.626	2.626	5.733	ns
		GCLK PLL	t_{CO}	1.184	1.184	2.627	ns
SSTL-18 CLASS I	6 mA	GCLK	t_{CO}	2.630	2.630	5.694	ns
		GCLK PLL	t_{CO}	1.185	1.185	2.582	ns
SSTL-18 CLASS I	8 mA	GCLK	t_{CO}	2.609	2.609	5.675	ns
		GCLK PLL	t_{CO}	1.164	1.164	2.563	ns
SSTL-18 CLASS I	10 mA	GCLK	t_{CO}	2.614	2.614	5.673	ns
		GCLK PLL	t_{CO}	1.169	1.169	2.561	ns
SSTL-18 CLASS I	12 mA	GCLK	t_{CO}	2.608	2.608	5.659	ns
		GCLK PLL	t_{CO}	1.163	1.163	2.547	ns
SSTL-18 CLASS II	8 mA	GCLK	t_{CO}	2.597	2.597	5.625	ns
		GCLK PLL	t_{CO}	1.152	1.152	2.513	ns

Table 4–57. EP1AGX35 Column Pins Output Timing Parameters (Part 2 of 4)

I/O Standard	Drive Strength	Clock	Parameter	Fast Corner		–6 Speed Grade	Units
				Industrial	Commercial		
3.3-V LVCMOS	24 mA	GCLK	t_{CO}	2.627	2.627	5.724	ns
		GCLK PLL	t_{CO}	1.185	1.185	2.618	ns
2.5 V	4 mA	GCLK	t_{CO}	2.726	2.726	6.201	ns
		GCLK PLL	t_{CO}	1.284	1.284	3.095	ns
2.5 V	8 mA	GCLK	t_{CO}	2.674	2.674	5.939	ns
		GCLK PLL	t_{CO}	1.232	1.232	2.833	ns
2.5 V	12 mA	GCLK	t_{CO}	2.653	2.653	5.822	ns
		GCLK PLL	t_{CO}	1.211	1.211	2.716	ns
2.5 V	16 mA	GCLK	t_{CO}	2.635	2.635	5.748	ns
		GCLK PLL	t_{CO}	1.193	1.193	2.642	ns
1.8 V	2 mA	GCLK	t_{CO}	2.766	2.766	7.193	ns
		GCLK PLL	t_{CO}	1.324	1.324	4.087	ns
1.8 V	4 mA	GCLK	t_{CO}	2.771	2.771	6.419	ns
		GCLK PLL	t_{CO}	1.329	1.329	3.313	ns
1.8 V	6 mA	GCLK	t_{CO}	2.695	2.695	6.155	ns
		GCLK PLL	t_{CO}	1.253	1.253	3.049	ns
1.8 V	8 mA	GCLK	t_{CO}	2.697	2.697	6.064	ns
		GCLK PLL	t_{CO}	1.255	1.255	2.958	ns
1.8 V	10 mA	GCLK	t_{CO}	2.651	2.651	5.987	ns
		GCLK PLL	t_{CO}	1.209	1.209	2.881	ns
1.8 V	12 mA	GCLK	t_{CO}	2.652	2.652	5.930	ns
		GCLK PLL	t_{CO}	1.210	1.210	2.824	ns
1.5 V	2 mA	GCLK	t_{CO}	2.746	2.746	6.723	ns
		GCLK PLL	t_{CO}	1.304	1.304	3.617	ns
1.5 V	4 mA	GCLK	t_{CO}	2.682	2.682	6.154	ns
		GCLK PLL	t_{CO}	1.240	1.240	3.048	ns
1.5 V	6 mA	GCLK	t_{CO}	2.685	2.685	6.036	ns
		GCLK PLL	t_{CO}	1.243	1.243	2.930	ns
1.5 V	8 mA	GCLK	t_{CO}	2.644	2.644	5.983	ns
		GCLK PLL	t_{CO}	1.202	1.202	2.877	ns
SSTL-2 CLASS I	8 mA	GCLK	t_{CO}	2.629	2.629	5.762	ns
		GCLK PLL	t_{CO}	1.184	1.184	2.650	ns
SSTL-2 CLASS I	12 mA	GCLK	t_{CO}	2.612	2.612	5.712	ns
		GCLK PLL	t_{CO}	1.167	1.167	2.600	ns
SSTL-2 CLASS II	16 mA	GCLK	t_{CO}	2.590	2.590	5.639	ns
		GCLK PLL	t_{CO}	1.145	1.145	2.527	ns
SSTL-2 CLASS II	20 mA	GCLK	t_{CO}	2.591	2.591	5.626	ns
		GCLK PLL	t_{CO}	1.146	1.146	2.514	ns

Table 4–57. EP1AGX35 Column Pins Output Timing Parameters (Part 3 of 4)

I/O Standard	Drive Strength	Clock	Parameter	Fast Corner		–6 Speed Grade	Units
				Industrial	Commercial		
SSTL-2 CLASS II	24 mA	GCLK	t_{CO}	2.587	2.587	5.624	ns
		GCLK PLL	t_{CO}	1.142	1.142	2.512	ns
SSTL-18 CLASS I	4 mA	GCLK	t_{CO}	2.626	2.626	5.733	ns
		GCLK PLL	t_{CO}	1.184	1.184	2.627	ns
SSTL-18 CLASS I	6 mA	GCLK	t_{CO}	2.630	2.630	5.694	ns
		GCLK PLL	t_{CO}	1.185	1.185	2.582	ns
SSTL-18 CLASS I	8 mA	GCLK	t_{CO}	2.609	2.609	5.675	ns
		GCLK PLL	t_{CO}	1.164	1.164	2.563	ns
SSTL-18 CLASS I	10 mA	GCLK	t_{CO}	2.614	2.614	5.673	ns
		GCLK PLL	t_{CO}	1.169	1.169	2.561	ns
SSTL-18 CLASS I	12 mA	GCLK	t_{CO}	2.608	2.608	5.659	ns
		GCLK PLL	t_{CO}	1.163	1.163	2.547	ns
SSTL-18 CLASS II	8 mA	GCLK	t_{CO}	2.597	2.597	5.625	ns
		GCLK PLL	t_{CO}	1.152	1.152	2.513	ns
SSTL-18 CLASS II	16 mA	GCLK	t_{CO}	2.609	2.609	5.603	ns
		GCLK PLL	t_{CO}	1.164	1.164	2.491	ns
SSTL-18 CLASS II	18 mA	GCLK	t_{CO}	2.605	2.605	5.611	ns
		GCLK PLL	t_{CO}	1.160	1.160	2.499	ns
SSTL-18 CLASS II	20 mA	GCLK	t_{CO}	2.605	2.605	5.609	ns
		GCLK PLL	t_{CO}	1.160	1.160	2.497	ns
1.8-V HSTL CLASS I	4 mA	GCLK	t_{CO}	2.629	2.629	5.664	ns
		GCLK PLL	t_{CO}	1.187	1.187	2.558	ns
1.8-V HSTL CLASS I	6 mA	GCLK	t_{CO}	2.634	2.634	5.649	ns
		GCLK PLL	t_{CO}	1.189	1.189	2.537	ns
1.8-V HSTL CLASS I	8 mA	GCLK	t_{CO}	2.612	2.612	5.638	ns
		GCLK PLL	t_{CO}	1.167	1.167	2.526	ns
1.8-V HSTL CLASS I	10 mA	GCLK	t_{CO}	2.616	2.616	5.644	ns
		GCLK PLL	t_{CO}	1.171	1.171	2.532	ns
1.8-V HSTL CLASS I	12 mA	GCLK	t_{CO}	2.608	2.608	5.637	ns
		GCLK PLL	t_{CO}	1.163	1.163	2.525	ns
1.8-V HSTL CLASS II	16 mA	GCLK	t_{CO}	2.591	2.591	5.401	ns
		GCLK PLL	t_{CO}	1.146	1.146	2.289	ns
1.8-V HSTL CLASS II	18 mA	GCLK	t_{CO}	2.593	2.593	5.412	ns
		GCLK PLL	t_{CO}	1.148	1.148	2.300	ns
1.8-V HSTL CLASS II	20 mA	GCLK	t_{CO}	2.593	2.593	5.421	ns
		GCLK PLL	t_{CO}	1.148	1.148	2.309	ns
1.5-V HSTL CLASS I	4 mA	GCLK	t_{CO}	2.629	2.629	5.663	ns
		GCLK PLL	t_{CO}	1.187	1.187	2.557	ns

Table 4–96 lists clock timing specifications.

Table 4–96. EP1AGX90 Row Pins Global Clock Timing Parameters

Parameter	Fast Model		–6 Speed Grade	Units
	Industrial	Commercial		
t_{CIN}	1.904	1.904	4.376	ns
t_{COUT}	1.904	1.904	4.376	ns
t_{PLLCIN}	–0.153	–0.153	0.254	ns
$t_{PLLCOUT}$	–0.153	–0.153	0.254	ns

Table 4–97 through Table 4–98 list the RCLK clock timing parameters for EP1AGX90 devices.

Table 4–97 lists clock timing specifications.

Table 4–97. EP1AGX90 Row Pins Regional Clock Timing Parameters

Parameter	Fast Model		–6 Speed Grade	Units
	Industrial	Commercial		
t_{CIN}	1.462	1.462	3.407	ns
t_{COUT}	1.467	1.467	3.401	ns
t_{PLLCIN}	–0.430	–0.430	–0.322	ns
$t_{PLLCOUT}$	–0.425	–0.425	–0.328	ns

Table 4–98 lists clock timing specifications.

Table 4–98. EP1AGX90 Row Pins Regional Clock Timing Parameters

Parameter	Fast Model		–6 Speed Grade	Units
	Industrial	Commercial		
t_{CIN}	1.760	1.760	4.011	ns
t_{COUT}	1.760	1.760	4.011	ns
t_{PLLCIN}	–0.118	–0.118	0.303	ns
$t_{PLLCOUT}$	–0.118	–0.118	0.303	ns

Block Performance

Table 4–99 shows the Arria GX performance for some common designs. All performance values were obtained with the Quartus II software compilation of library of parameterized modules (LPM) or MegaCore functions for finite impulse response (FIR) and fast Fourier transform (FFT) designs.